TOSHIBA

TOSHIBA Original CMOS 16-Bit Microcontroller

TLCS-900 Series

TMP96PM40

TOSHIBA CORPORATION

Preface

Thank you very much for making use of Toshiba microcomputer LSIs.
Before use this LSI, refer the section, "Points of Note and Restrictions".
Especially, take care below cautions.

CAUTION

How to release the HALT mode

Usually, interrupts can release all halts status. However, the interrupts = ($\overline{\text{NMI}}$, INT0), which can release the HALT mode may not be able to do so if they are input during the period CPU is shifting to the HALT mode (for about 3 clocks of X1) with IDLE or STOP mode. (In this case, an interrupt request is kept on hold internally.)

If another interrupt is generated after it has shifted to HALT mode completely, halt status can be released without difficultly. The priority of this interrupt is compare with that of the interrupt kept on hold internally, and the interrupt with higher priority is handled first followed by the other interrupt.

CMOS 16-bit Microcontrollers

TMP96PM40F

1. Outline and Device Characteristics

TMP96PM40F is high-speed advanced 16-bit microcontrollers developed for controlling medium to large-scale equipment. The TMP96C141BF does not have a ROM, the TMP96CM40F has a built-in ROM of 32K-byte, and the TMP96PM40 has a built-in OTP of 32K-byte.

It is possible to do write / verify of program data with using a adapter socket and general purpose EPROM writer (TC571000 mode).

TMP96PM40 is pin compatible with TMP96CM40 (mask ROM type).

TMP96CM40F is housed in an 80-pin flat package.

Product name	ROM	RAM	Package	Adapter socket name
TMP96PM40F	OTP type 32 K × 8 bit	1 K × 8 bit	80-FP	BM1139A

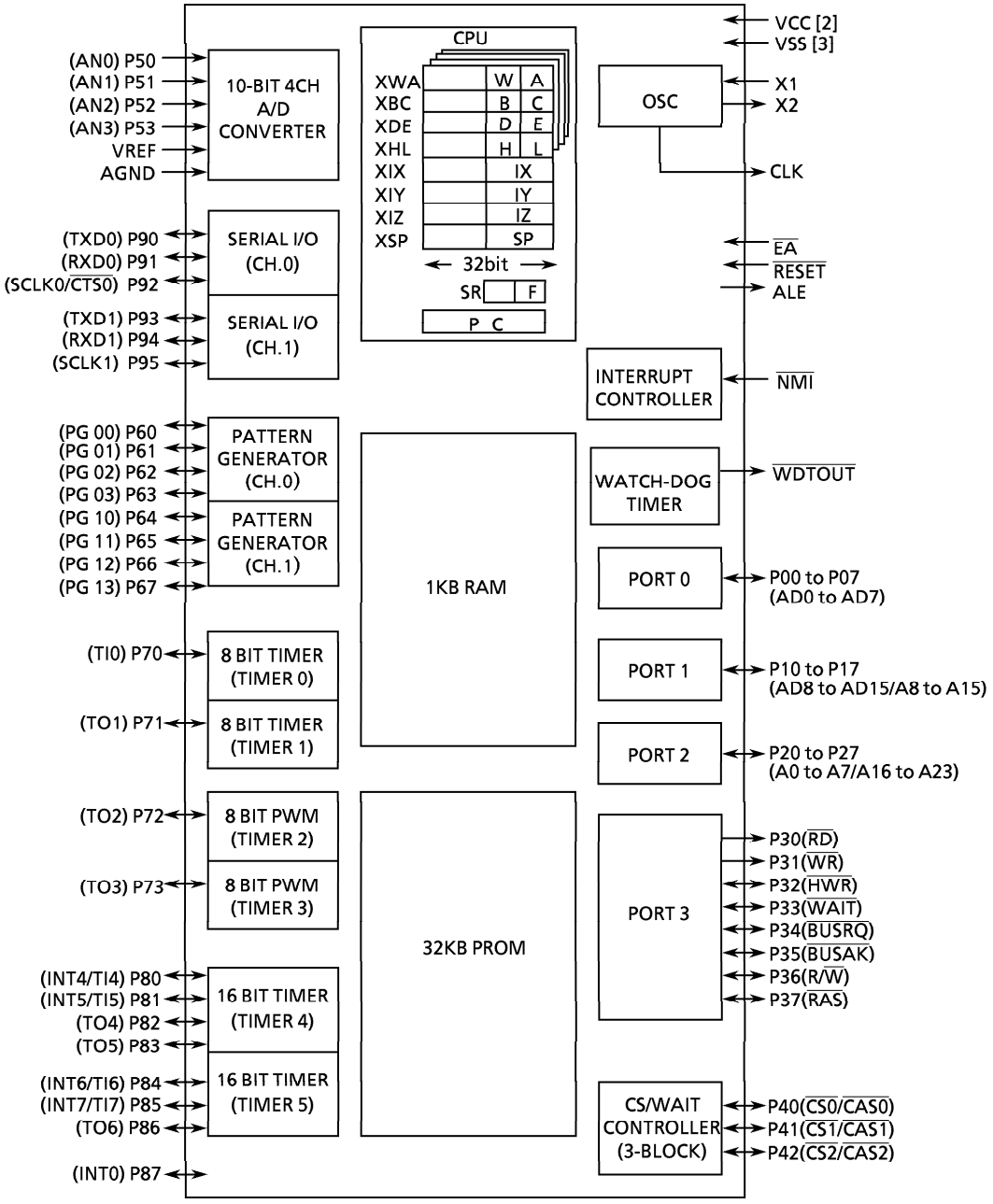


Figure1 TMP96PM40 Block Diagram

2. Pin Assignment and Functions

The assignment of input / output pins for TMP96PM40, their name and outline functions are described below.

2.1 Pin Assignment

Figure 2.1 shows pin assignment of TMP96PM40F.

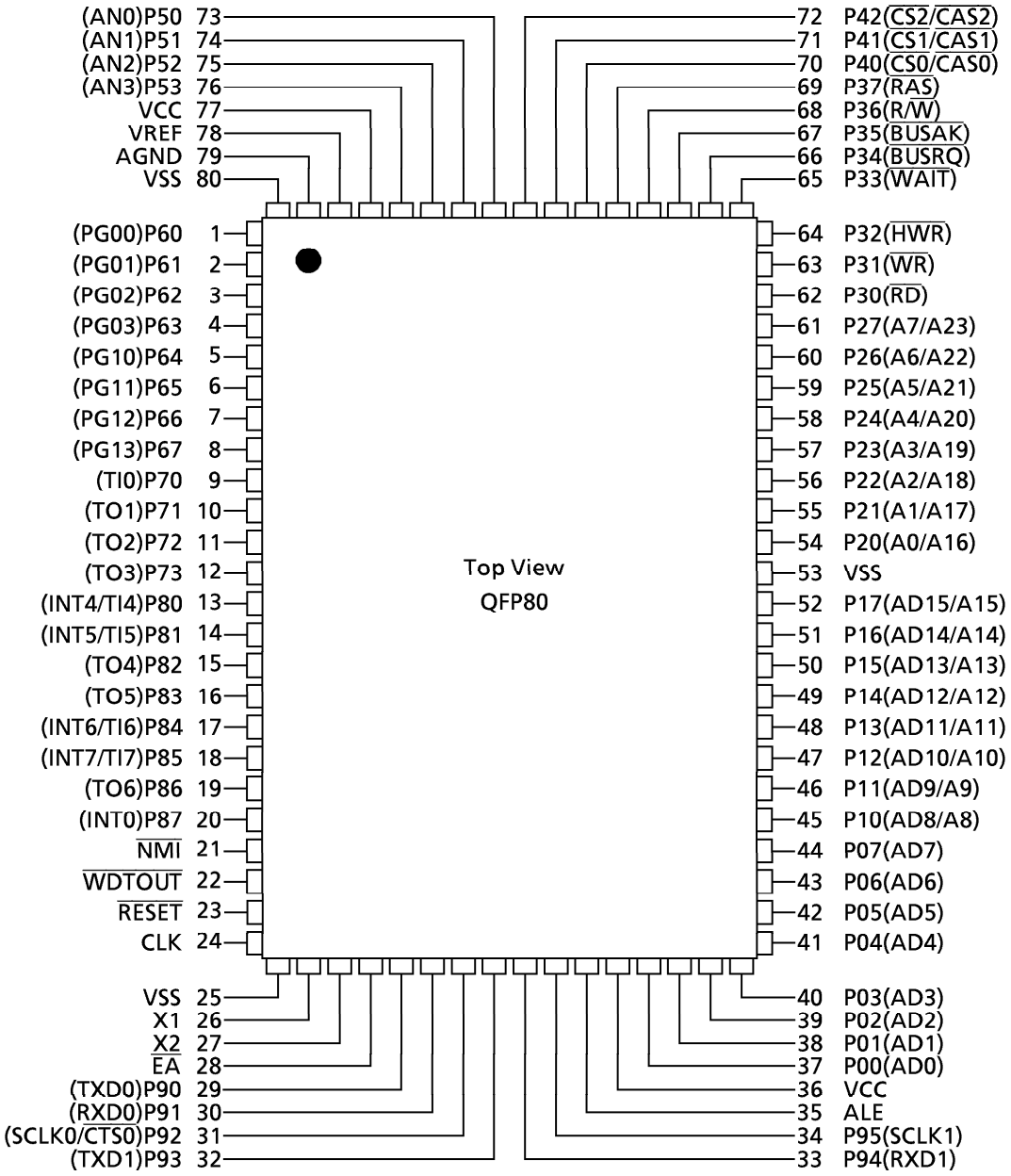


Figure 2.1 Pin Assignment (80-pin QFP)

2.2 Pin Names and Functions

TMP96PM40 has MCU mode and PROM mode.
The names of input/output pins and their functions are described below.

(1) MCU mode

Table 2.2 (1) Pin Names and Functions.

Pin name	Number of pins	I/O	Functions
P00 to P07 AD0 to AD7	8	I/O Tri-state	Port 0: I/O port that allows I/O to be selected on a bit basis Address/data (lower): 0 to 7 for address/data bus
P10 to P17 AD8 to AD15 A8 to A15	8	I/O Tri-state Output	Port 1: I/O port that allows I/O to be selected on a bit basis Address data (upper): 8 to 15 for address/data bus Address: 8 to 15 for address bus
P20 to P27 A0 to A7 A16 to A23	8	I/O Output Output	Port 2: I/O port that allows selection of I/O on a bit basis (with pull-down resistor) Address: 0 to 7 for address bus Address: 16 to 23 for address bus
P30 $\overline{RD}$	1	Output Output	Port 30: Output port Read: Strobe signal for reading external memory
P31 $\overline{WR}$	1	Output Output	Port 31: Output port Write: Strobe signal for writing data on pins AD0 to 7
P32 $\overline{HWR}$	1	I/O Output	Port 32: I/O port (with pull-up resistor) High write: Strobe signal for writing data on pins AD8 to 15
P33 $\overline{WAIT}$	1	I/O Input	Port 33: I/O port (with pull-up resistor) Wait: Pin used to request CPU bus wait
P34 $\overline{BUSRQ}$	1	I/O Input	Port34: I/O port (with pull-up resistor) Bus request: Signal used to request high impedance for AD0 to 15, A0 to 23, $\overline{RD}$, $\overline{WR}$,$\overline{HWR}$, R/$\overline{W}$, $\overline{RAS}$, $\overline{CS0}$, $\overline{CS1}$, and $\overline{CS2}$ pins. (For external DMAC)
P35 $\overline{BUSAK}$	1	I/O Output	Port 35: I/O port (with pull-up resistor) Bus acknowledge: Signal indicating that AD0 to 15, A0 to 23, $\overline{RD}$, $\overline{WR}$,$\overline{HWR}$, R/$\overline{W}$, $\overline{RAS}$, $\overline{CS0}$, $\overline{CS1}$, and $\overline{CS2}$ pins are at high impedance after receiving BUSRQ. (For external DMAC)
P36 R/$\overline{W}$	1	I/O Output	Port 36: I/O port (with pull-up resistor) Read/write: 1 represents read or dummy cycle; 0, write cycle.
P37 $\overline{RAS}$	1	I/O Output	Port 37: I/O port (with pull-up resistor) Row address strobe: Outputs RAS strobe for DRAM.
P40 $\overline{CS0}$ $\overline{CAS0}$	1	I/O Output Output	Port 40: I/O port (with pull-up resistor) Chip select 0: Outputs 0 when address is within specified address area. Column address strobe 0: Outputs CAS strobe for DRAM when address is within specified address area.

Note : With the external DMA controller, this device's built-in memory or built-in I/O cannot be accessed using the $\overline{BUSRQ}$ and $\overline{BUSAK}$ pins.

Pin name	Number of pins	I/O	Functions
P41 $\overline{CS1}$ $\overline{CAS1}$	1	I/O Output Output	Port 41: I/O port (with pull-up resistor) Chip select 1: Outputs 0 if address is within specified address area. Column address strobe 1: Outputs $\overline{CAS}$ strobe for DRAM if address is within specified address area.
P42 $\overline{CS2}$ $\overline{CAS2}$	1	I/O Output Output	Port 42: I/O port (with pull-down resistor) (Note) Chip select 2: Outputs 0 if address is within specified address area. Column address strobe 2: Outputs $\overline{CAS}$ strobe for DRAM if address is within specified address area.
P50 to P53 AN0 to AN3	4	Input Input	Port 5: Input port Analog input: Input to A/D converter
VREF	1	Input	Pin for reference voltage input to A/D converter
AGND	1	Input	Ground pin for A/D converter
P60 to P63 PG00 to PG03	4	I/O Output	Ports 60 to 63: I/O ports that allow selection of I/O on a bit basis (with pull-up resistor) Pattern generator ports: 00 to 03
P64 to P67 PG10 to PG13	4	I/O Output	Ports 64 to 67: I/O ports that allow selection of I/O on a bit basis (with pull-up resistor) Pattern generator ports: 10 to 13
P70 TI0	1	I/O Input	Port 70: I/O port (with pull-up resistor) Timer input 0: Timer 0 input
P71 TO1	1	I/O Output	Port 71: I/O port (with pull-up resistor) Timer output 1: Timer 0 or 1 output
P72 TO2	1	I/O Output	Port 72: I/O port (with pull-up resistor) PWM output 2: 8-bit PWM timer 2 output
P73 TO3	1	I/O Output	Port 73: I/O port (with pull-up resistor) PWM output 3: 8-bit PWM timer 3 output
P80 TI4 INT4	1	I/O Input Input	Port 80: I/O port (with pull-up resistor) Timer input 4: Timer 4 count/capture trigger signal input Interrupt request pin 4: Interrupt request pin with programmable rising/falling edge
P81 TI5 INT5	1	I/O Input Input	Port 81: I/O port (with pull-up resistor) Timer input 5: Timer 4 count/capture trigger signal input Interrupt request pin 5: Interrupt request pin with rising edge
P82 TO4	1	I/O Output	Port 82: I/O port (with pull-up resistor) Timer output 4: Timer 4 output pin
P83 TO5	1	I/O Output	Port 83: I/O port (with pull-up resistor) Timer output 5: Timer 4 output pin

Note : Case of the settable $\overline{CS2}$ or $\overline{CAS2}$; when TMP96PM40F is bus release, this pin is not added the internal pull-down resistor but is added the internal pull-up resistor.

Pin name	Number of pins	I/O	Functions
P84 TI6 INT6	1	I/O Input Input	Port 84: I/O port (with pull-up resistor) Timer input 6: Timer 5 count/capture trigger signal input Interrupt request pin 6: Interrupt request pin with programmable rising/falling edge
P85 TI7 INT7	1	I/O Input Input	Port 85: I/O port (with pull-up resistor) Timer input 7: Timer 5 count/capture trigger signal input Interrupt request pin 7: Interrupt request pin with rising edge
P86 TO6	1	I/O Output	Port 86: I/O port (with pull-up resistor) Timer output 6: Timer 5 output pin
P87 INT0	1	I/O Input	Port 87: I/O port (with pull-up resistor) Interrupt request pin 0: Interrupt request pin with programmable level/rising edge
P90 TXD0	1	I/O Output	Port 90: I/O port (with pull-up resistor) Serial send data 0
P91 RXD0	1	I/O Input	Port 91: I/O port (with pull-up resistor) Serial receive data 0
P92 $\overline{\text{CTS0}}$ SCLK0	1	I/O Input I/O	Port 92: I/O port (with pull-up resistor) Serial data send enable 0 (Clear to Send) Serial clock I/O 0
P93 TXD1	1	I/O Output	Port 93: I/O port (with pull-up resistor) Serial send data 1
P94 RXD1	1	I/O Input	Port 94: I/O port (with pull-up resistor) Serial receive data 1
P95 SCLK1	1	I/O I/O	Port 95: I/O port (with pull-up resistor) Serial clock I/O 1
$\overline{\text{WDTOUT}}$	1	Output	Watchdog timer output pin
$\overline{\text{NMI}}$	1	Input	Non-maskable interrupt request pin: Interrupt request pin with falling edge. Can also be operated at rising edge by program.
CLK	1	Output	Clock output: Outputs「X1÷4」clock. Pulled-up during reset.
$\overline{\text{EA}}$	1	Input	External access: 0 should be inputted with TMP96C141B. 1, with TMP96CM40 / TMP96PM40.
ALE	1	Output	Address latch enable
$\overline{\text{RESET}}$	1	Input	Reset: Initializes LSI. (With pull-up resistor)
X1/X2	2	I/O	Oscillator connecting pin
VCC	2		Power supply pin (+ 5 V) (All Vcc pins should be connected with the power supply pin.)
VSS	3		GND pin (0 V) (All Vss pins should be connected with GND (0 V).)

Note : Pull-up/pull-down resistor can be released from the pin by software (except the $\overline{\text{RESET}}$ pin).

(2) PROMmode

Table 2.2 (2) Name and function of PROM mode

Pin function	Pin number	Input / Output	Function	Pin name (MCU mode)
A7 to A0	8	Input	Memory address of program	P27 to P20
A15 to A8	8	Input		P17 to P10
A16	1	Input		P33
D7 to D0	8	I/O	Memory data of pfogram	P07 to P00
$\overline{CE}$	1	Input	Chip enable	P32
$\overline{OE}$	1	Input	Output control	P30
$\overline{PGM}$	1	Input	Program control	P31
VPP	1	Power supply	12.75 V / 5 V (Power supply of program)	$\overline{EA}$
VCC	2	Power supply	6.25 V / 5 V	VCC
VSS	3	Power supply	0 V	VSS
Pin function	**Pin number**	**Input / Output**	**Disposal of pin**	
P34	1	Input	Fix to low level (security pin)	
$\overline{RESET}$	1	Input	Fix to low level (PROM mode)	
CLK	1	Input		
ALE	1	Output	Open	
X1	1	Input	Crystal	
X2	1	Output		
P95 to P94, VREF	3	Input	Fix to high level	
AGND	1	Input	0V	
P37 to P35 P42 to P40 P53 to P50 P67 to P60 P73 to P70 P87 to P80 $\overline{NMI}$, $\overline{WDTOUT}$ P93 to P90	36	I/O	open	

3. Operation

This section describes the hardware and basic operation of TMP96PM40 device. TMP96PM40 is exchanged mask ROM of TMP96CM40 for PROM. The other specifications and functions are the same as TMP96CM40.

Check the 「7. Care Points and Restriction of TMP96C141B」 because of the Care described. Regarding the function of TMP96PM40 (not described), see the part of TMP96CM40 for ports functions and bus release functions, and see the part of TMP96C141B for other functions.

The operation modes are MCU mode and PROM mode.

TMP96C141B/TMP96CM40/TMP96PM40 have much the same function but they are different from following points.

Parameter	TMP96C141B	TMP96CM40	TMP96PM40
Interrnal ROM	Not exist	Mask ROM32 Kbyte	PROM32 Kbyte
P00 to P07, AD0 to AD7	Only AD0 to AD7	After reset P00 to P07	
P10 to P17, AD8 to AD15, A8 to A15	Only AD8 to AD15	After reset P10 to P17	
P30, $\overline{RD}$	Only $\overline{RD}$	After reset P30	
P31, $\overline{WR}$	Only $\overline{WR}$	After reset P31	
Pin state at the bus release	TMP96C141B see Table 3.5 (1)	TMP96CM40 see Table 3.3 (1)	

3.1 MCU mode

(1) Mode-setting and function

The MCU mode is set by opening the CLK pin (Output status).

In the MCU mode, the operation is same as that of TMP96CM40.

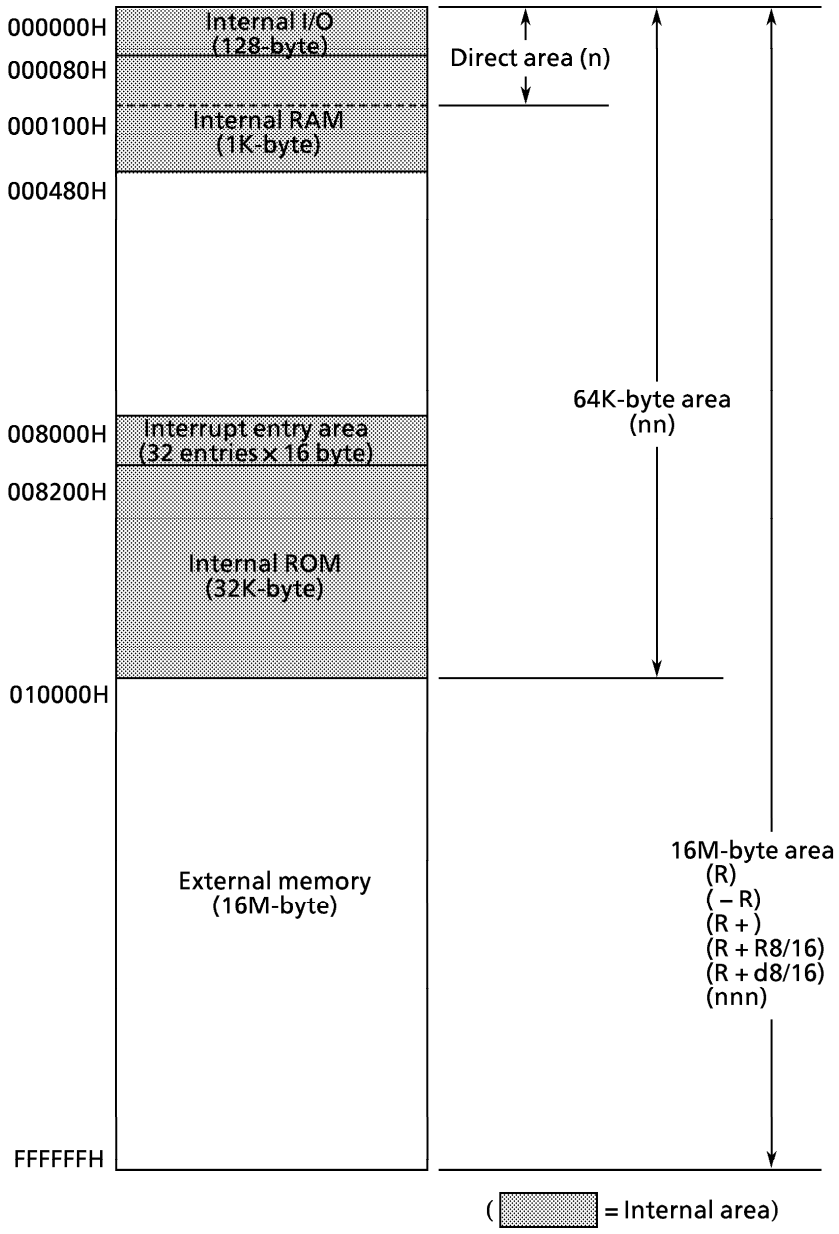
(2) Memory Map

The memory map of TMP96PM40 is same as that of TMP96CM40.

Figure 3.1 shows the memory map of TMP96PM40, and the accessing area by the respective addressing mode.

Memory Map

Figure 3.1 is a memory map of the TMP96CM40.



Note : The start address after reset is 8000H. Resetting sets the stack pointer (XSP) on the system mode side to 100H.

Figure3.1 Memory map

4. Electrical Characteristics

4.1 Absolute Maximum Ratings (TMP96PM40)

Parameter	Symbol	Rating	Unit
Power Supply voltage	V cc	– 0.5 to 6.5	V
Input voltage	V IN	– 0.5 to Vcc + 0.5	V
Output Current (total)	Σ IOL	100	mA
Output Current (total)	Σ IOH	– 100	mA
Power Dissipation (Ta = 70℃)	P D	500	mW
Soldering Temperature (10 s)	T SOLDER	260	℃
Storage temperature	T STG	– 65 to 150	℃
Operating temperature	T OPR	– 40 to 85	℃

Note : The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

4.2 DC Characteristics (TMP96PM40)

Vcc = 5 V ± 10%, TA = – 20 to 70℃ (4 to 20 MHz) TA = – 40 to 85℃ (4 to 16 MHz)

(Typical values are for Ta = 25℃ and Vcc = 5 V.)

Parameter	Symbol	Test Condition	Min	Max	Unit
Input Low Voltage (AD0 to 15) P2, P3, P4, P5, P6, P7, P8, P9 RESET,NMI,INT0(P87) EA X1	V IL V IL1 V IL2 V IL3 V IL4		– 0.3 – 0.3 – 0.3 – 0.3 – 0.3	0.8 0.3 Vcc 0.25 Vcc 0.3 0.2 Vcc	V V V V V
Input High Voltage (AD0 – 15) P2, P3, P4, P5, P6, P7, P8, P9 RESET, NMI, INT0 (P87) EA X1	V IH V IH1 V IH2 V IH3 V IH4		2.2 0.7 Vcc 0.75 Vcc Vcc – 0.3 0.8 Vcc	Vcc + 0.3 Vcc + 0.3 Vcc + 0.3 Vcc + 0.3 Vcc + 0.3	V V V V V
Output Low Voltage	V OL	I OL = 1.6 mA		0.45	V
Output High Voltage	V OH V OH1 V OH2	I OH = – 400 μA I OH = – 100 μA I OH = – 20 μA	2.4 0.75 Vcc 0.9 Vcc		V V V
Darlington Drive Current (8 Output Pins max.)	I DAR	V EXT = 1.5 V R EXT = 1.1 kΩ	– 1.0	– 3.5	mA
Input Leakage Current Output Leakage Current	I LI I LO	0.0 ≦ Vin ≦ Vcc 0.2 ≦ Vin ≦ Vcc – 0.2	0.02 (Typ) 0.05 (Typ)	± 5 ± 10	μA μA
Operating Current (RUN) IDLE STOP (Ta = – 40 to 85℃) STOP (Ta = 0 to 50℃)	I cc	fc = 20 MHz 0.2 ≦ Vin ≦ Vcc – 0.2 0.2 ≦ Vin ≦ Vcc – 0.2	30 (Typ) 2.0 (Typ) 0.2 (Typ)	60 10 50 10	mA mA μA μA
Power Down Voltage (@ STOP, RAM Back up)	V STOP	V IL2 = 0.2 Vcc, V IH2 = 0.8 Vcc	2.0	6.0	V
RESET Pull Up Resistor	R RST		50	150	kΩ
Pin Capacitance	C IO	fc = 1 MHz		10	pF
Schmitt Width RESET, NMI, INT0 (P87)	V TH		0.4	1.0 (Typ)	V
Programmable Pull Down Resistor	R KL		10	80	kΩ
Programmable Pull Up Resistor	R KH		50	150	kΩ

Note : I-DAR is guaranteed for a total of up to 8 ports.

4.3 AC Electrical Characteristics (TMP96PM40)

Vcc = 5 V ± 10% TA = – 40 to 85℃ (4 to 16 MHz) , TA = – 20 to 70℃ (4 to 20 MHz)

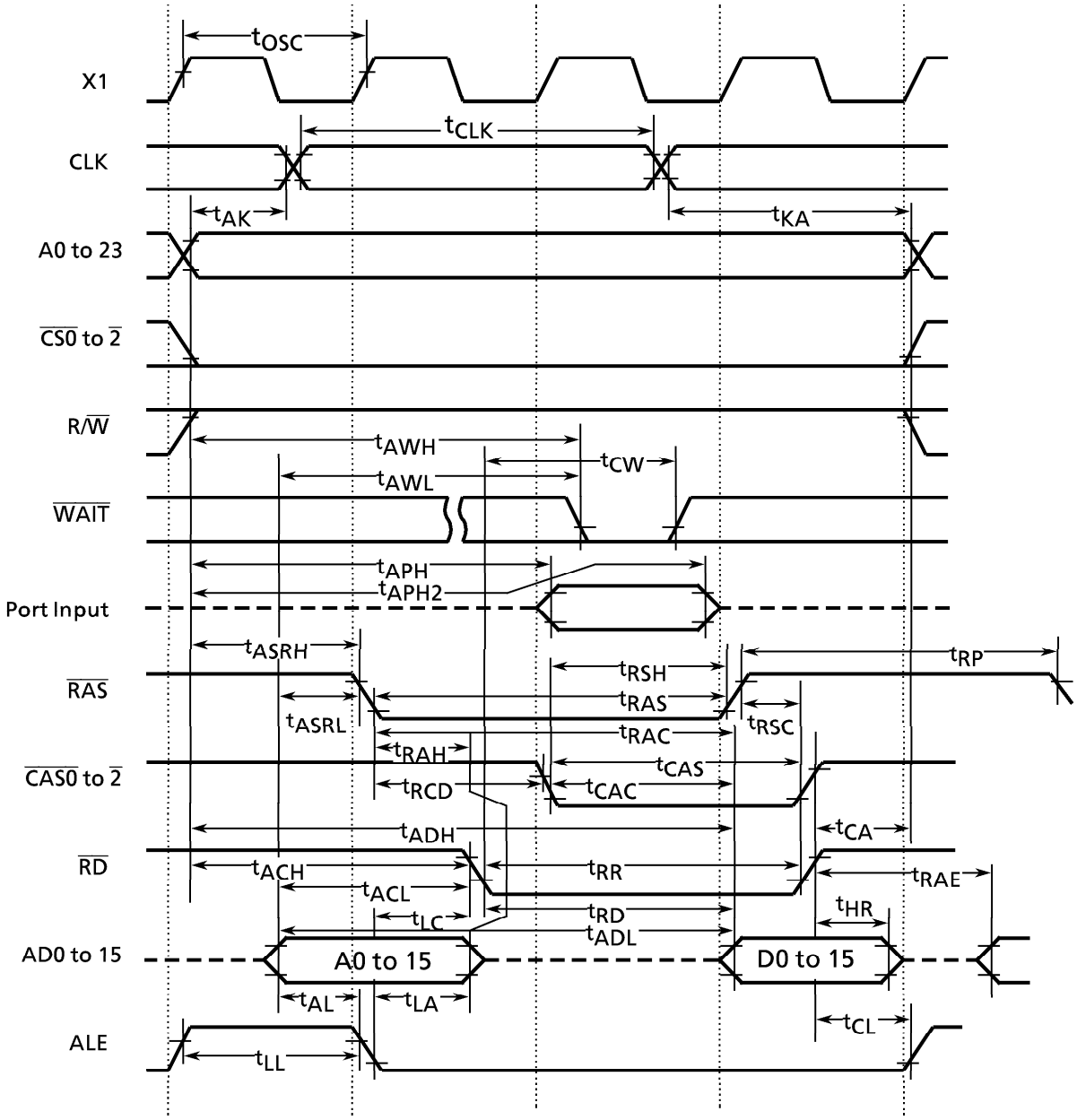
No.	Paramerer	Symbol	Variable		16 MHz		20 MHz		Unit
			Min	Max	Min	Max	Min	Max	
1	Osc. Period (= x)	t_{OSC}	50	250	62.5		50		ns
2	CLK width	t_{CLK}	2x – 40		85		60		ns
3	A0 to 23 Valid → CLK Hold	t_{AK}	0.5x – 20		11		5		ns
4	CLK Valid → A0 to 23 Hold	t_{KA}	1.5x – 70		24		5		ns
5	A0 to 15 Valid → ALE fall	t_{AL}	0.5x – 15		16		10		ns
6	ALE fall → A0 to 15 Hold	t_{LA}	0.5x – 15		16		10		ns
7	ALE High width	t_{LL}	x – 40		23		10		ns
8	ALE fall → $\overline{RD}/\overline{WR}$ fall	t_{LC}	0.5x – 30		1		-5		ns
9	$\overline{RD}/\overline{WR}$ rise → ALE rise	t_{CL}	0.5x – 20		11		5		ns
10	A0 to 15 Valid → $\overline{RD}/\overline{WR}$ fall	t_{ACL}	x – 25		38		25		ns
11	A0 to 23 Valid → $\overline{RD}/\overline{WR}$ fall	t_{ACH}	1.5x – 50		44		25		ns
12	$\overline{RD}/\overline{WR}$ rise → A0 to 23 Hold	t_{CA}	0.5x – 20		11		5		ns
13	A0 to 15 Valid → D0 to 15 input	t_{ADL}*		3.0x – 55		133		95	ns
14	A0 to 23 Valid → D0 to 15 input	t_{ADH}		3.5x – 65		154		110	ns
15	$\overline{RD}$fall → D0 to 15 input	t_{RD}		2.0x – 50		75		50	ns
16	$\overline{RD}$ Low width	t_{RR}	2.0x – 40		85		60		ns
17	$\overline{RD}$rise → D0 to 15 Hold	t_{HR}	0		0		0		ns
18	$\overline{RD}$rise → A0 to 15output	t_{RAE}	x – 15		48		35		ns
19	$\overline{WR}$ Low width	t_{WW}	2.0x – 40		85		60		ns
20	D0 to 15 Valid → $\overline{WR}$rise	t_{DW}	2.0x – 50		75		50		ns
21	$\overline{WR}$ rise →D0 to 15 Hold	t_{WD}	0.5x – 10		21		15		ns
22	A0 to 23 Valid → $\overline{WAIT}$ input $\left(\begin{smallmatrix}1WAIT\\+n\ mode\end{smallmatrix}\right)$	t_{AEH}		3.5x – 90		129		85	ns
23	A0 to 15 Valid → $\overline{WAIT}$ input $\left(\begin{smallmatrix}1WAIT\\+n\ mode\end{smallmatrix}\right)$	t_{AWL}		3.0x – 80		108		70	ns
24	$\overline{RD}/\overline{WR}$ fall → $\overline{WAIT}$ Hold $\left(\begin{smallmatrix}1WAIT\\+n\ mode\end{smallmatrix}\right)$	t_{CW}	2.0x + 0		125		100		ns
25	A0 to 23 Valid → PORT input	t_{APH}		2.5x – 120		36		5	ns
26	A0 to 23 Valid → PORT Hold	t_{APH2}	2.5x + 50		206		175		ns
27	$\overline{WR}$ rise → PORT Valid	t_{CP}		200		200		200	ns
28	A0 to 23 Valid → $\overline{RAS}$ fall	t_{ASRH}	1.0x – 40		23		10		ns
29	A0 to 15 Valid → $\overline{RAS}$ fall	t_{ASRL}	0.5x – 15		16		10		ns
30	$\overline{RAS}$ fall → D0 to 15 input	t_{RAC}		2.5x – 70		86		55	ns
31	$\overline{RAS}$ fall → A0 to 15 Hold	t_{RAH}	0.5x – 15		16		10		ns
32	$\overline{RAS}$ Low width	t_{RAS}	2.0x – 40		85		60		ns
33	$\overline{RAS}$ High width	t_{RP}	2.0x – 40		85		60		ns
34	$\overline{CAS}$ fall → $\overline{RAS}$ rise	t_{RSH}	1.0x – 35		28		15		ns
35	$\overline{RAS}$ rise → $\overline{CAS}$ rise	t_{RSC}	0.5x – 25		6		0		ns
36	$\overline{RAS}$ fall → $\overline{CAS}$ fall	t_{RCD}	1.0x – 40		23		10		ns
37	$\overline{CAS}$ fall → D0 to 15 input	t_{CAC}		1.5x – 65		29		10	ns
38	$\overline{CAS}$ Low width	t_{CAS}	1.5x – 30		64		40		ns

* t_{ADL} value is different from TMP96C141B/TMP96CM40.

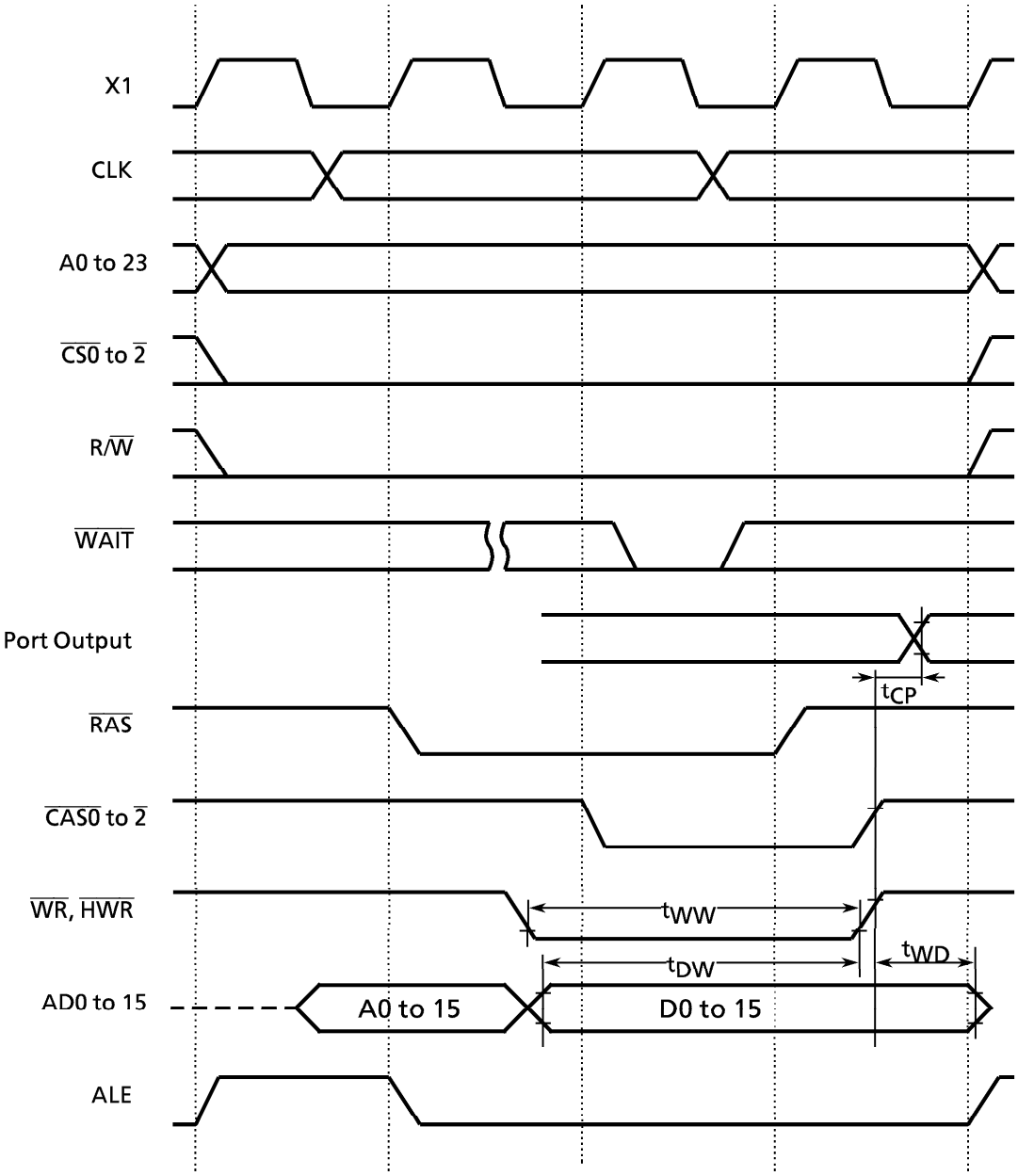
AC Measuring Conditions

- Output Level : High 2.2 V / Low 0.8 V , CL50 pF
  (However CL = 100 pF for AD0 to AD15, A0 to A23, ALE, $\overline{RD}$, $\overline{WR}$, $\overline{HWR}$, R/$\overline{W}$, CLK, $\overline{RAS}$, $\overline{CAS0}$ to $\overline{CAS2}$)
- Input Level : High 2.4V / Low 0.45V (AD0 to AD15)
  High 0.8Vcc / Low 0.2Vcc (Except for AD0 to AD15)

(1) Read Cycle


X1
CLK
A0 to 23
CS0 to 2
R/W
WAIT
Port Input
RAS
CAS0 to 2
RD
AD0 to 15
ALE
tOSC
tCLK
tAK
tKA
tAWH
tAWL
tCW
tAPH
tAPH2
tASRH
tASRL
tRSH
tRAS
tRP
tRSC
tRAC
tRAH
tCAS
tRCD
tCAC
tADH
tCA
tACH
tACL
tRR
tRAE
tLC
tRD
tADL
tHR
A0 to 15
D0 to 15
tAL
tLA
tCL
tLL

(2) Write Cycle



4.4 A/D Conversion Characteristics (TMP96PM40)

Vcc = 5 V ± 10% TA = – 40 to 85°C (4 to 16 MHz) TA = – 20 to 70°C (4 to 20 MHz)

Parameter		Symbol	Min	Typ.	Max	Unit
Analog reference voltage		V_{REF}	Vcc – 1.5		Vcc	V
Analog reference voltage		A_{GND}	Vss		Vss	
Analog input voltage range		V_{AIN}	Vss		Vcc	
Anlog current for analog reference voltage		I_{REF}		0.5	1.5	mA
4≦fc≦16 MHz	Low change mode	Total error(Quantize error of ± 0.5 LSB not included)		± 1.5	± 4.0	LSB
	High change mode			± 3.0	± 6.0	
16<fc≦20 MHz	Low change mode			± 1.5	± 4.0	
	High change mode			± 4.0	± 8.0	

4.5 Serial Channel Timing – I/O Interface Mode

(1) SCLK Input Mode Vcc = 5 V ± 10% TA = – 40 to 85°C (4 to 16 MHz) TA = – 20 to 70°C (4 to 20 MHz)

Parameter	Symbol	Variable		16 MHz		20 MHz		Unit
		Min	Max	Min	Max	Min	Max	
SCLK cycle	t_{SCY}	16X		1		0.8		μs
Output Data → Rising edge of SCLK	t_{OSS}	t_{SCY}/2 – 5X – 50		137		100		ns
SCLK rising edge→ Output Data hold	t_{OHS}	5X – 100		212		150		ns
SCLK rising edge→ Input Data hold	t_{HSR}	0		0		0		ns
SCLK rising edge→ effective data input	t_{SRD}		t_{SCY} – 5X – 100		587		450	ns

(2) SCLK Output Mode Vcc = 5 V ± 10% TA = – 40 to 85°C (4 to 16 MHz) TA = – 20 to 70°C (4 to 20 MHz)

Parameter	Symbol	Variable		16 MHz		20 MHz		Unit
		Min	Max	Min	Max	Min	Max	
SCLK cycle (programmable)	t_{SCY}	16X	8192X	1	512	0.8	409.6	μs
Output Data → SCLK rising edge	t_{OSS}	t_{SCY} – 2X – 150		725		550		ns
SCLK rising edge→ Output Data hold	t_{OHS}	2X – 80		45		20		ns
SCLK rising edge→ Input Data hold	t_{HSR}	0		0		0		ns
SCLK rising edge→ effective data input	t_{SRD}		t_{SCY} – 2X – 150		725		550	ns

4.6 Timer/Counter Input Clock (TI0, TI4, TI5, TI6, TI7)

Vcc = 5 V ± 10% TA = – 40 to 85°C (4 to 16 MHz) TA = – 20 to 70°C (4 to 20 MHz)

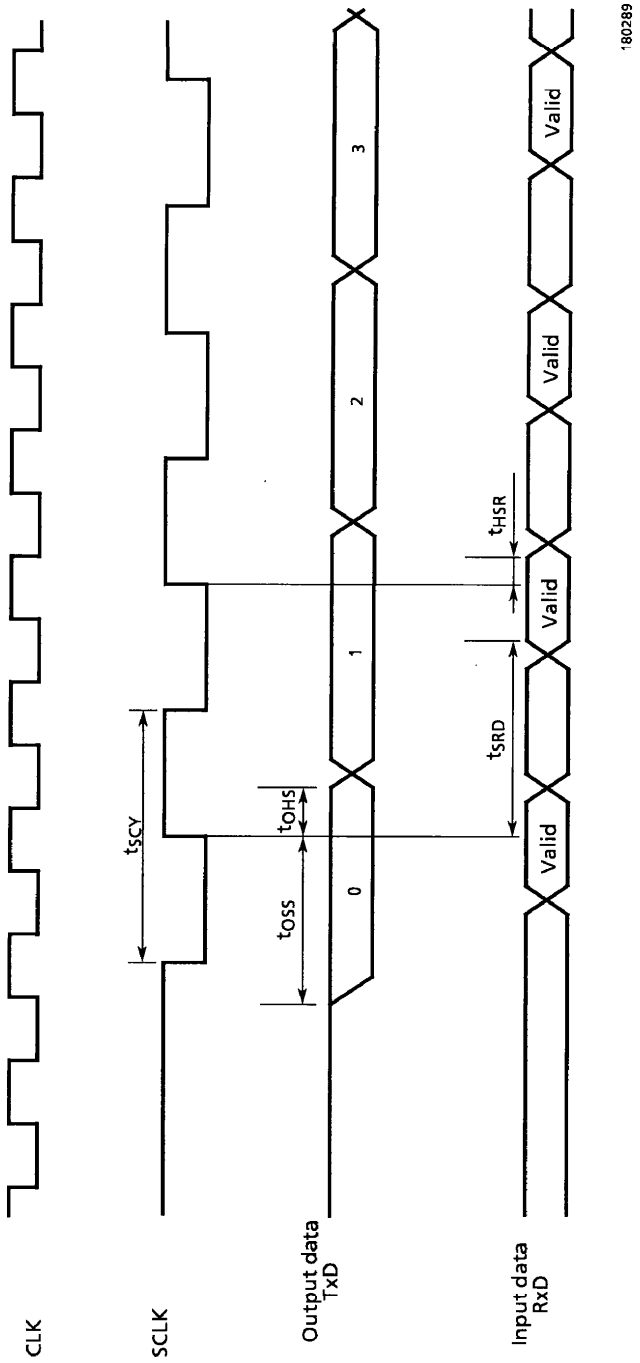
Parameter	Symbol	Variable		16 MHz		20 MHz		Unit
		Min	Max	Min	Max	Min	Max	
Clock Cycle	t_{VCK}	8X + 100		600		500		ns
Low level clock Pulse width	t_{VCKL}	4X + 40		290		240		ns
High level clock Pulse width	t_{VCKH}	4X + 40		290		240		ns

4.7 Interrupt Operation

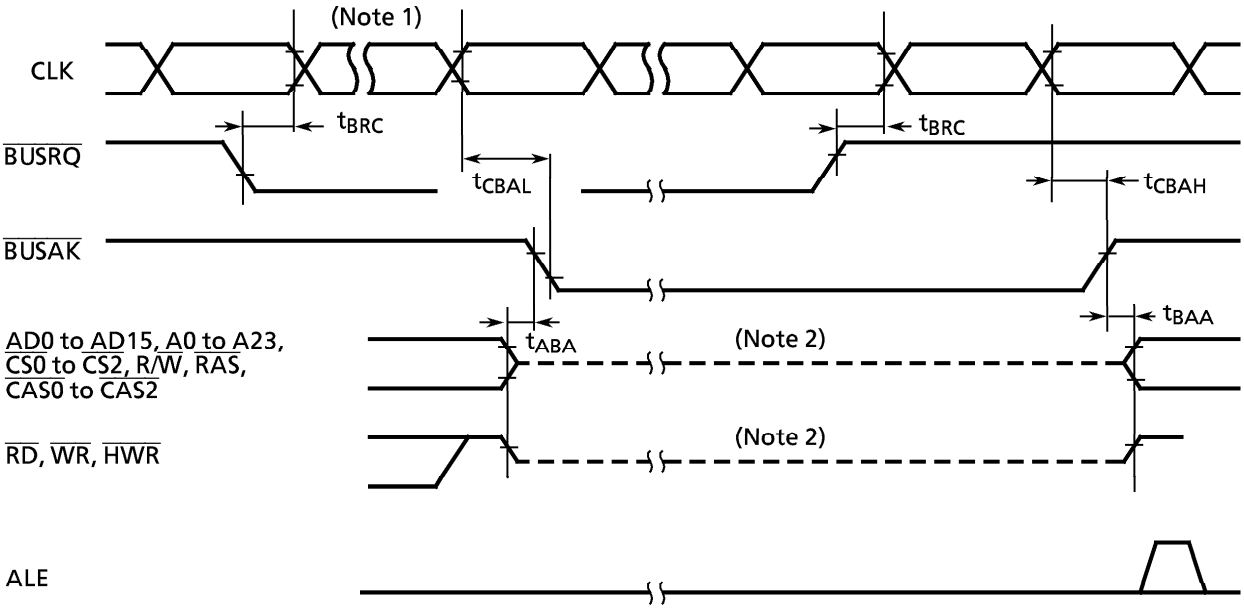
Vcc = 5 V ± 10% TA = – 40 to 85°C (4 to 16 MHz) TA = – 20 to 70°C (4 to 20 MHz)

Parameter	Symbol	Variable		16 MHz		20 MHz		Unit
		Min	Max	Min	Max	Min	Max	
$\overline{NMI}$, INT0 Low level Pulse width	t_{INTAL}	4X		250		200		ns
$\overline{NMI}$, INT0 High level Pulse width	t_{INTAH}	4X		250		200		ns
INT4 to INT7 Low level Pulse width	t_{INTBL}	8X + 100		600		500		ns
INT4 to INT7 High level Pulse width	t_{INTBH}	8X + 100		600		500		ns

4.8 Timing Chart for I/O Interface Mode



4.9 Timing Chart for Bus Request ($\overline{BUSRQ}$) / BUS Acknowledge ($\overline{BUSAK}$)



Parameter	Symbol	Variable		16 MHz		20 MHz		Unit
		Min	Max	Min	Max	Min	Max	
$\overline{BUSRQ}$ set-up time for CLK	t_{BRC}	120		120		120		ns
CLK→ $\overline{BUSAK}$ falling edge	t_{CBAL}		1.5x + 120		214		195	ns
CLK→ $\overline{BUSAK}$ rising edge	t_{CBAH}		0.5x + 40		71		65	ns
Output Buffer is off to $\overline{BUSAK}$ ↓	t_{ABA}	0	80	0	80	0	80	ns
$\overline{BUSAK}$ ↑ to Output Buffer is on.	t_{BAA}	0	80	0	80	0	80	ns

Note 1: The Bus will be released after the $\overline{WAIT}$ request is inactive, when the $\overline{BUSRQ}$ is set to "0" during "Wait" cycle.

Note 2: This line only shows the output buffer is off-state.
They don't indicate the signal level is fixed.
After the bus is released, the signal level is kept dynamically before the bus is released by the external capacitance.
Therefore, to fix the signal level by an external resistance under the bus is releasing, the design must be carefully because of the level-fix will be delayed.
The internal programmable pull-up/pull-down resistance is switched active/non-active by the internal signal.

4.10 Read Operation (PROM Mode)

DC Characteristic, AC Characteristic

TA = −40 to 85°C Vcc = 5 V ± 10%

Parameter	Symbol	Condition	Min	Max	Unit
V_{PP} Read Voltage	V_{PP}	−	4.5	5.5	V
Input High Voltage (A0 to A16, $\overline{CE}$, $\overline{OE}$, $\overline{PGM}$)	V_{IH1}	−	$0.7 \times V_{CC}$	$V_{CC} + 0.3$	V
Input Low Voltage (A0 to A16, $\overline{CE}$, $\overline{OE}$, $\overline{PGM}$)	V_{IL1}	−	−0.3	$0.3 \times V_{CC}$	V
Address to Output Delay	t_{ACC}	C_L = 50 pF	−	2.25 TCYC + α	ns

TCYC = 400 ns (10 MHz Clock)
α = 200 ns

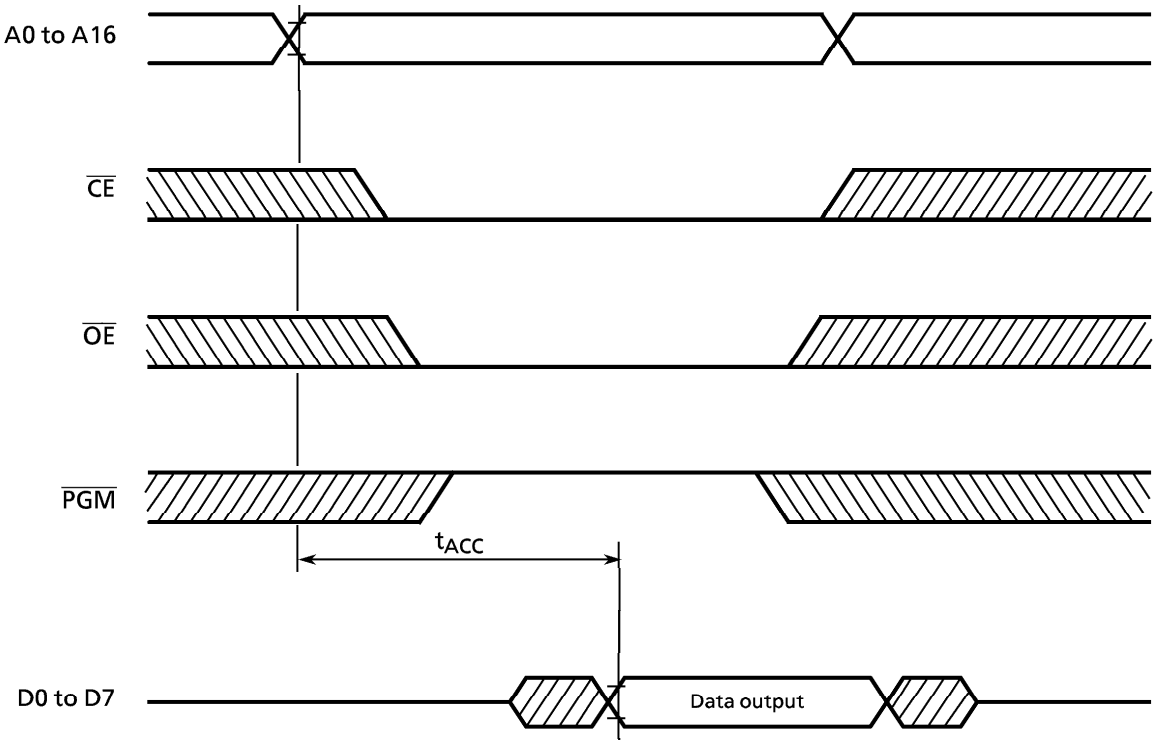
4.11 Programming Operation (PROM Mode)

DC Characteristic, AC Characteristic

TA = 25 ± 5°C Vcc = 6.25 V ± 0.25 V

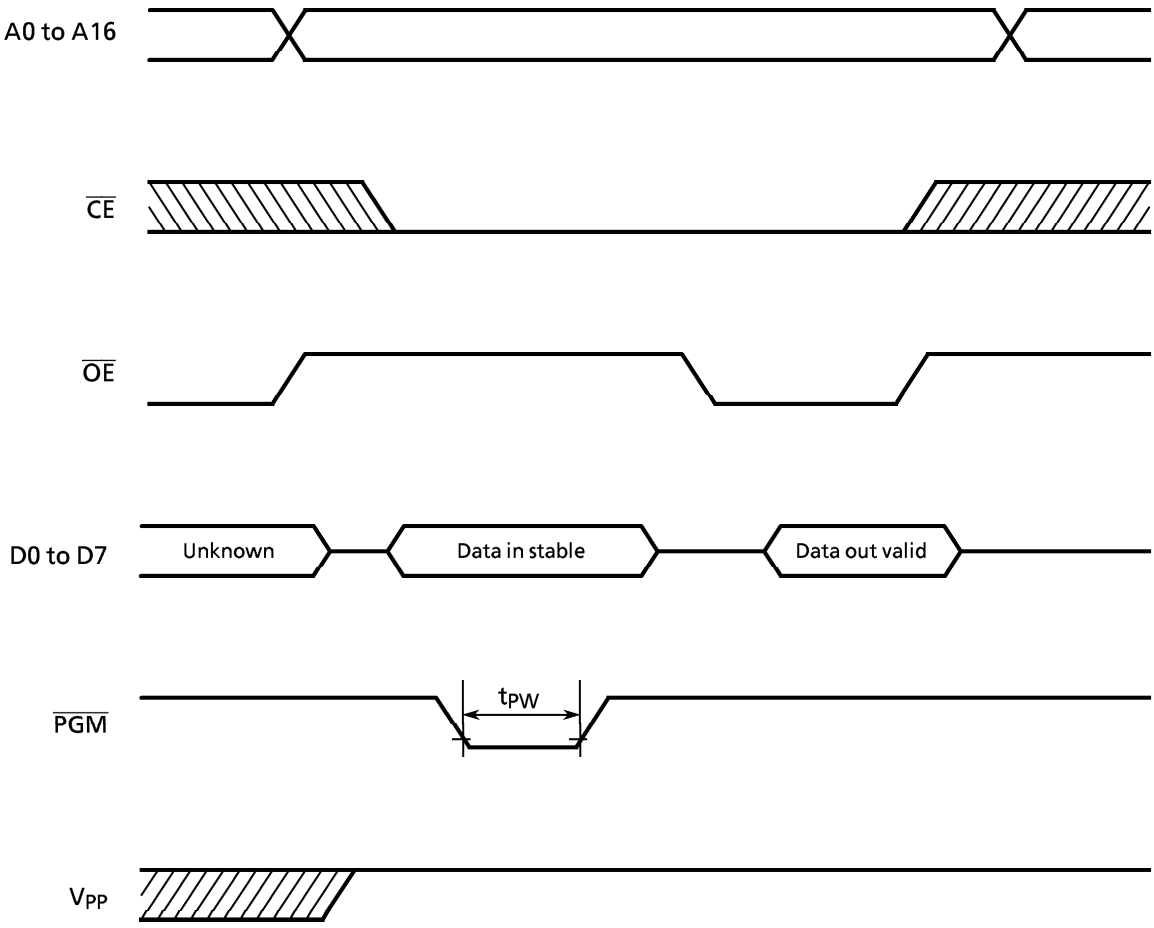
Parameter	Symbol	Condition	Min	Typ.	Max	Unit
Programing Supply Voltage	V_{PP}	−	12.50	12.75	13.00	V
Input High Voltage (D0 to D7)	V_{IH}	−	$0.2V_{CC} + 1.1$		$V_{CC} + 0.3$	V
Input Low Voltage (D0 to D7)	V_{IL}	−	−0.3		$0.2V_{CC}$-0.1	V
Input High Voltage (A0 to A16, $\overline{CE}$, $\overline{OE}$, $\overline{PGM}$)	V_{IH1}	−	$0.7V_{CC}$		$V_{CC} + 0.3$	V
Input Low Voltage (A0 to A16, $\overline{CE}$, $\overline{OE}$, $\overline{PGM}$)	V_{IL1}	−	−0.3		$0.3V_{CC}$	V
V_{CC} Supply Current	I_{CC}	fc = 10 MHz	−		50	mA
V_{PP} Supply Current	I_{PP}	V_{PP} = 13.00 V	−		50	mA
$\overline{PGM}$ Program Pulse Width	t_{PW}	C_L = 50 pF	0.095	0.1	0.105	ms

4.12 Read Operation Timing Chart (PROM Mode)



4.13 Programming Operation Timing Chart (PROM Mode)

High Speed Program Writing.



Note 1: The power supply of V_{PP} (12.75 V) must be set power-on at the same time or the later time for a power supply of V_{CC} and must be clear power-on at the same time or early time for a power supply of V_{CC}.

Note 2: The pulling up/down device on condition of $V_{PP} = 12.75$ V suffer a damage for the device.

Note 3: The maximum spec of V_{PP} pin is 14.0 V. Be carefull a overshoot at the program writing.

4.14 Typical Characteristics

Vcc = 5 V, Ta = 25°C, Unless otherwise noted.

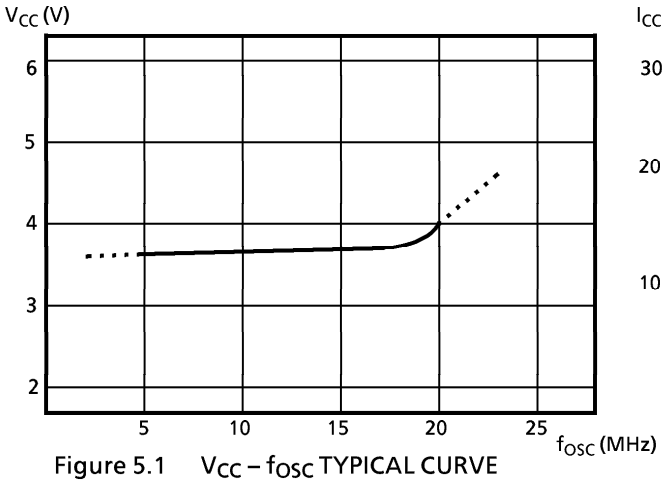


Figure 5.1 V_{CC} – f_{OSC} TYPICAL CURVE

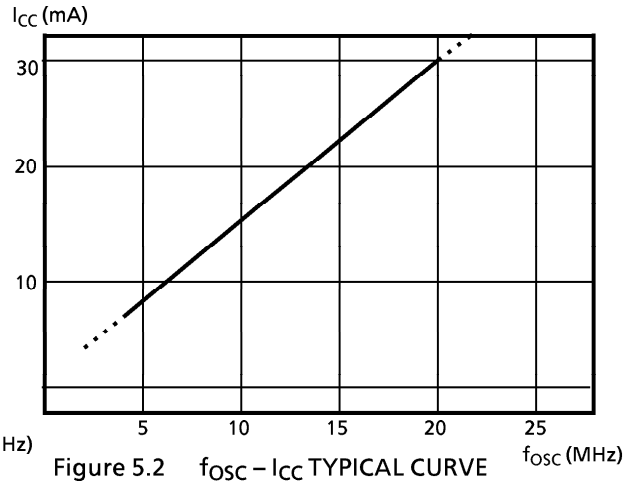


Figure 5.2 f_{OSC} – I_{CC} TYPICAL CURVE

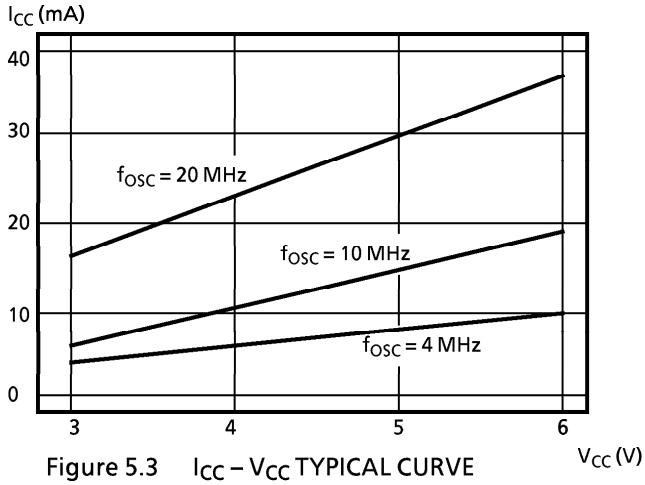


Figure 5.3 I_{CC} – V_{CC} TYPICAL CURVE

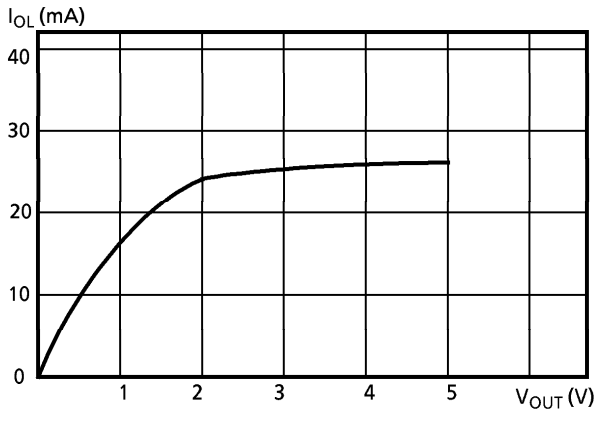


Figure 5.4 V_{OUT} – I_{OL} TYPICAL CURVE

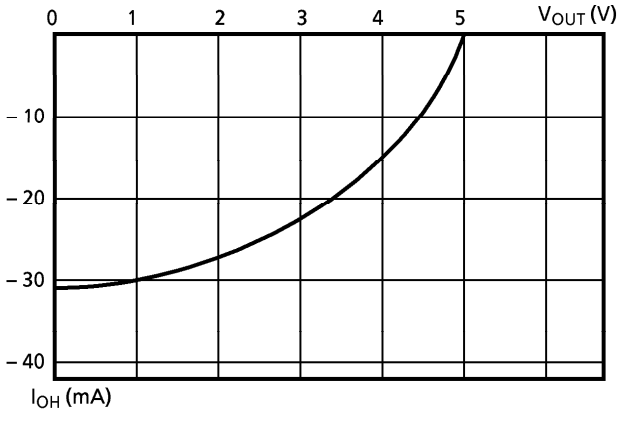


Figure 5.5 V_{OUT} – I_{OH} TYPICAL CURVE